

# **MOSFET** - N-Channel, POWERTRENCH®

200 V, 62 A, 27 m $\Omega$ 

## FDP2614

## **General Description**

This N-Channel MOSFET is produced using onsemi's advanced POWERTRENCH process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

#### **Features**

- $R_{DS(on)} = 22.9 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 31 \text{ A}$
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low R<sub>DS(on)</sub>
- High Power and Current Handing Capability
- This Device is Pb-Free, Halide Free and is RoHS Compliant

## **Applications**

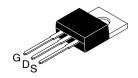
- Consumer Appliances
- Synchronous Rectification
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies

## MOSFET MAXIMUM RATINGS (T<sub>C</sub> = 25°C, unless otherwise noted)

Symbol		Parameter	Value	Unit
V <sub>DS</sub>	Drain to Source Voltage		200	V
V <sub>GS</sub>	Gate to Source	Gate to Source Voltage		V
I <sub>D</sub>	Drain Current	Continuous (T <sub>C</sub> = 25°C)	62	Α
		Continuous (T <sub>C</sub> = 100°C)	39.3	
I <sub>DM</sub>	Drain Current	Pulsed (Note 1)	see Figure 9	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy (Note 2)		145	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5	V/ns
$P_{D}$	Power Dissipation (T <sub>C</sub> = 25°C)		260	W
	Derate above 25	2.1	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to +150	°C
TL	Maximum Lead pose, 1/8" from	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

V <sub>DS</sub>	R <sub>DS(on)</sub> MAX	I <sub>D</sub> MAX
200 V	27 mΩ @ 10 V	62 A



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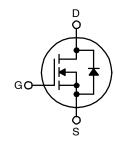
#### **MARKING DIAGRAM**

&Z&3&K FDP 2614

&Z = Assembly Plant Code &3 = 3-Digit Date Code

= 2-Digits Lot Run Traceability Code

FDP2614 = Specific Device Code



N-Channel

## ORDERING INFORMATION

Device	Package	Shipping		
FDP2614	TO-220-3LD	800 Units / Tube		

## THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
R <sub>θ</sub> JC	Thermal Resistance Junction to Case, Max.	0.48	°C/W
$R_{\thetaJA}$	Thermal Resistance Junction to Ambient, Max.	62.5	°C/W

## **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS					
B <sub>VDSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}, T_J = 25^{\circ}\text{C}$	200	_	_	V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, Referenced to 25°C	-	0.2	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V	-	_	10	μΑ
		V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125°C	-	_	500	1
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V	_	_	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V	_	_	-100	nA
ON CHARA	CTERISTICS		•		•	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.0	4.0	5.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 31 A	-	22.9	27	mΩ
9FS	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 31 A	-	72	-	S
DYNAMIC C	CHARACTERISTICS		•		•	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz	-	5435	7230	pF
C <sub>oss</sub>	Output Capacitance		-	505	675	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1	-	110	165	pF
SWITCHING	CHARACTERISTICS		•		•	
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD}$ = 100 V, $I_{D}$ = 62 A, $V_{GS}$ = 10 V, $R_{GEN}$ = 25 $\Omega$ (Note 4)	_	77	165	ns
t <sub>r</sub>	Turn-On Rise Time		-	284	560	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	1	-	103	220	ns
t <sub>f</sub>	Turn-Off Fall Time		-	162	335	ns
Qg	Total Gate Charge	V <sub>DS</sub> = 100 V, I <sub>D</sub> = 62 A, V <sub>GS</sub> = 10 V (Note 4)	-	76	99	nC
Q <sub>gs</sub>	Gate-Source Charge		-	35	-	nC
Q <sub>gd</sub>	Gate-Drain Charge	1	-	18	-	nC
DRAIN-SOL	JRCE DIODE CHARACTERISTICS AND	MAXIMUM RATINGS				
Is	Maximum Continuous Drain-Source Diode Forward Current		_	_	62	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode	Forward Current	-	-	186	Α
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 62 A	-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 62 A, dI <sub>F</sub> /dt = 100 A/μs	-	145	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	1	_	0.81	-	μС

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions performance may not be indicated by the Electrical Characteristics if operated under different conditions.
1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. L = 1 mH, I<sub>AS</sub> = 17 A, V<sub>DD</sub> = 50 V, R<sub>G</sub> = 25 Ω, Starting T<sub>J</sub> = 25°C
3. I<sub>SD</sub> ≤ 62 A, di/dt ≤ 100 A/ms, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C
4. Essentially Independent of Operating Temperature Typical Characteristics.

## TYPICAL PERFORMANCE CHARACTERISTICS

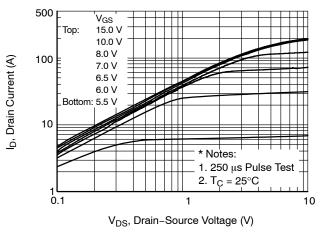


Figure 1. On-Region Characteristics

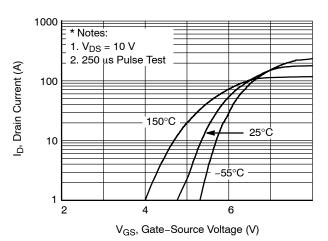


Figure 2. Transfer Characteristics

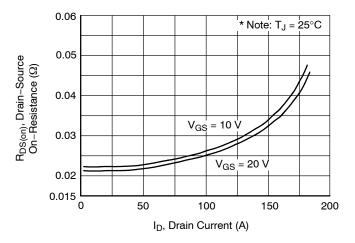


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

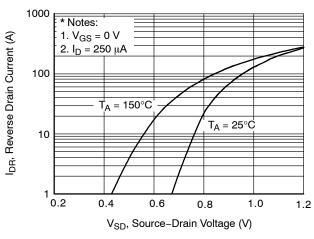


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

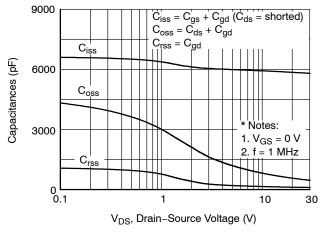


Figure 5. Capacitance Characteristics

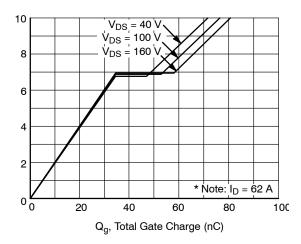
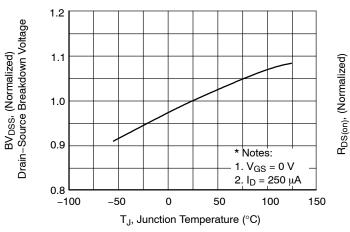


Figure 6. Gate Charge Characteristics

V<sub>GS</sub>, Gate-Source Voltage (V)

## TYPICAL PERFORMANCE CHARACTERISTICS (continued)

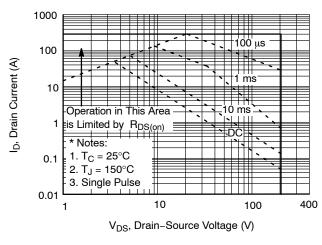
3.0



R<sub>DS(on)</sub>, (Normalized) Drain-Source On-Resistance 2.5 2.0 1.5 1.0 \* Notes: 0.5 1.  $V_{GS} = 10 V$ 2.  $I_D = 31 A$ 0.0 -100 -50 50 100 150 200 T<sub>J</sub>, Junction Temperature (°C)

Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On–Resistance Variation vs. Temperature



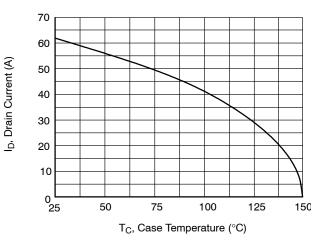


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

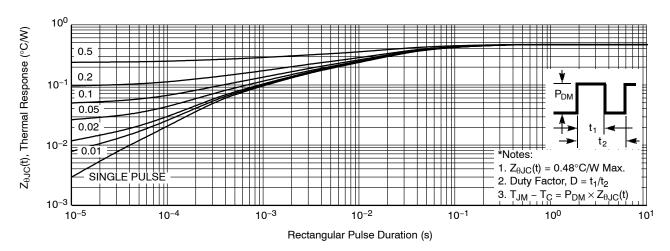


Figure 11. Transient Thermal Response Curve

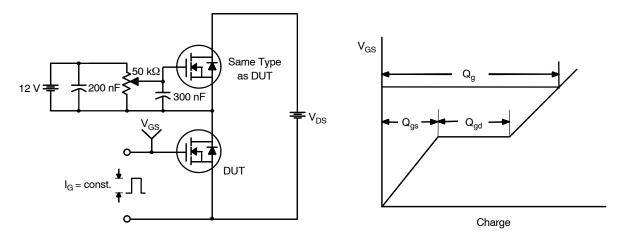


Figure 12. Gate Charge Test Circuit & Waveform

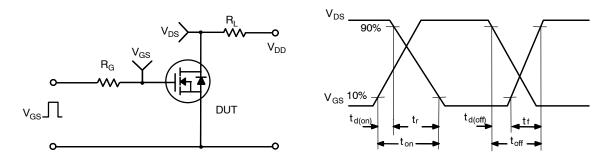


Figure 13. Resistive Switching Test Circuit & Waveforms

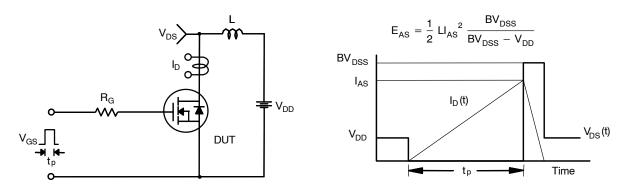


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

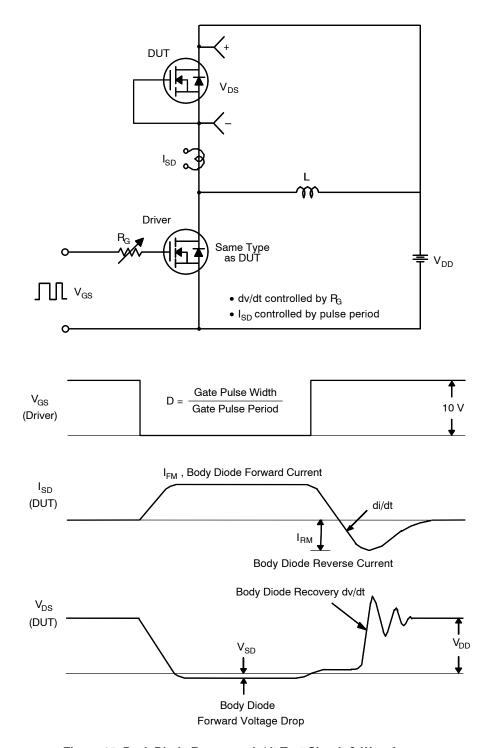


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

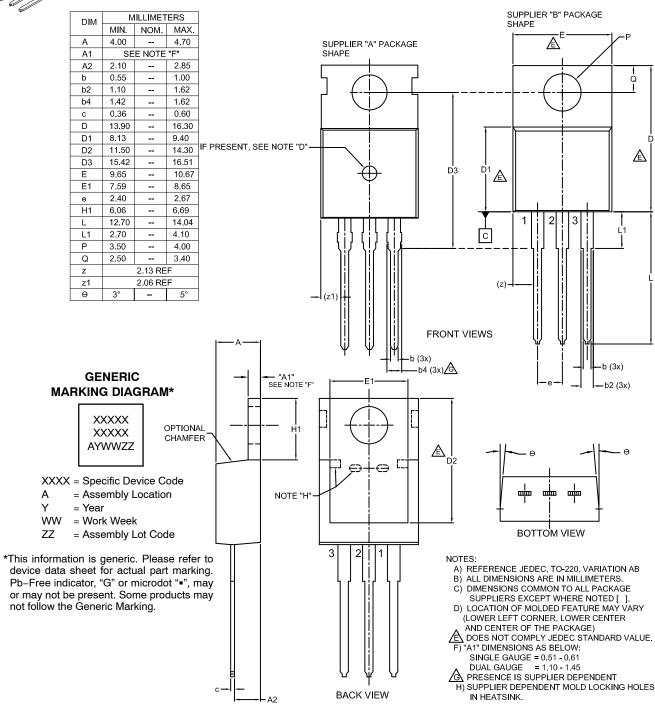
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